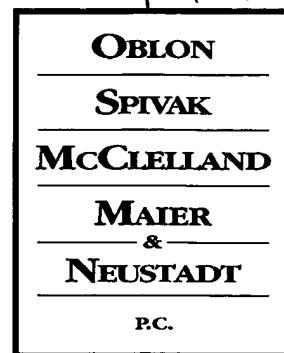




Docket No.: 210136US99

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231



ATTORNEYS AT LAW

RE: Application Serial No.: 09/901,109
Applicants: Ravindranath DROOPAD, et al.
Filing Date: July 10, 2001
For: STRUCTURE AND METHOD FOR FABRICATING
SEMICONDUCTOR STRUCTURES AND
DEVICES UTILIZING THE FORMATION OF A
COMPLIANT SUBSTRATE COMPRISING AN
OXYGEN-DOPED COMPOUND
SEMICONDUCTOR LAYER
Group Art Unit: 1775
Examiner: STEIN, S.J.

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SIR:

Attached hereto for filing are the following papers:

AMENDMENT W/MARKED-UP COPY OF CLAIMS

Our check in the amount of \$0.00 is attached covering any required fees. In the event any variance exists between the amount enclosed and the Patent Office charges for filing the above-noted documents, including any fees required under 37 C.F.R. 1.136 for any necessary Extension of Time to make the filing of the attached documents timely, please charge or credit the difference to our Deposit Account No. 15-0030. Further, if these papers are not considered timely filed, then a petition is hereby made under 37 C.F.R. 1.136 for the necessary extension of time. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.

Richard L. Treanor
Attorney of Record
Registration No. 36,379

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